

# **High Efficiency BCM LED Driver Controller for High Power Factor Offline Applications**

## **General Description**

The RT8487 is a Boundary mode high PF floating buck constant LED current output controller with an internal gate driver.

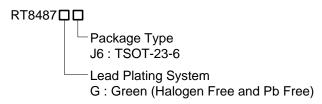
The RT8487 features a ZCS detector which keeps system operating in BCM and obtaining excellent power efficiency, better EMI performance.

The RT8487 achieves high power factor correction (PFC) and low total harmonic distortion of current (THDi) by a smart internal line voltage compensation circuit which has minimized system component counts; saved both PCB size and total system cost.

Especially, the RT8487 can use a cheap simple drum core inductor in the system instead of an EE core to obtain high efficiency.

The RT8487 is housed in a TSOT-23-6 package. Thus, the components in the whole LED driver system can be made very compact.

## Ordering Information

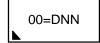


#### Note:

Richtek products are:

- ▶ RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

## Marking Information



00= : Product Code DNN : Date Code

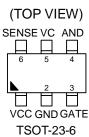
#### **Features**

- Support High Power Factor and THDi Consideration Applications
- Programmable Constant LED Current with Highly Precision Current Regulation
- Extremely Low Quiescent Current Consumption and 1μA Shutdown Current
- True Low System BOM Cost and Economical Floating Buck Converter Solution
- Unique Programmable AND Pin for ZVS Setting to Achieve Best Power Efficiency
- Universal Input Voltage Range with Off-Line Topology
- Built-in Over Thermal Protection
- Built-in Over Voltage Protection
- Output LED String Open Protection
- Output LED String Short Protection
- Output LED String Over Current Protection

## **Applications**

E27, PAR, Light Bar, Offline LED Lights

## **Pin Configuration**

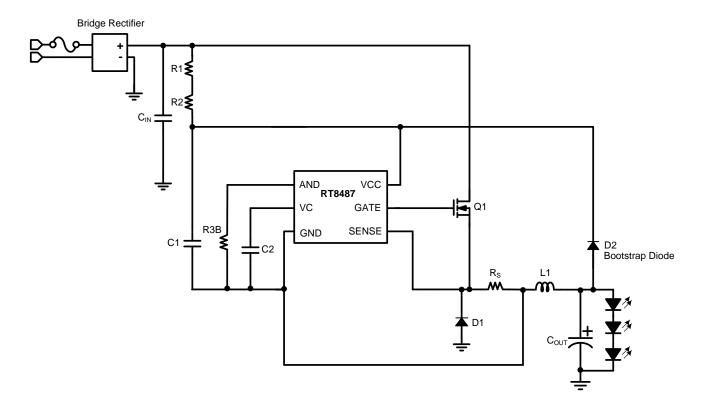


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# **Simplified Application Circuit**

Buck type:

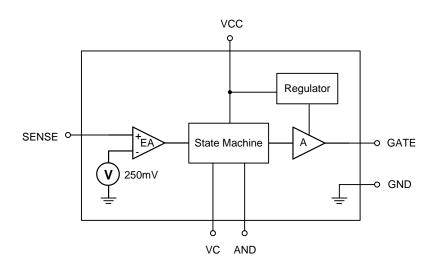




## **Functional Pin Description**

Pin No.	Pin Name	Pin Function		
1	VCC	Supply voltage input. For good bypass, a ceramic capacitor near the VCC pin is required.		
2	GND	Ground.		
3	GATE	Gate driver output for external MOSFET switch.		
4	AND	AND function pin.		
5	VC	Close loop compensation node.		
6	SENSE	LED current sense input. The typical sensing threshold is 250mV between the SENSE and GND pin.		

## **Functional Block Diagram**



## **Operation**

The RT8487 senses true average output current and keeps the system driving constant output current. The VC pin is the compensation node in this close loop system and dominates the frequency response. To stabilize the system and achieve better PFC / THDi, proper selection of a compensation network is needed.

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## **Absolute Maximum Ratings** (Note 1)

- Power Dissipation, P<sub>D</sub> @ T<sub>A</sub> = 25°C

TSOT-23-6------0.5W

• Package Thermal Resistance (Note 2)

TSOT-23-6, θJA ------ 197.4°C/W

- Lead Temperature (Soldering, 10 sec.)------260°C
- Junction Temperature ------ 150°C
- ESD Susceptibility (Note 3)

HBM (Human Body Model) ------2kV

## **Recommended Operating Conditions** (Note 4)

- Supply Input Voltage, VCC ------ 10V to 30V

## **Electrical Characteristics**

(V<sub>CC</sub> = 24V, T<sub>A</sub> = 25°C, unless otherwise specified)

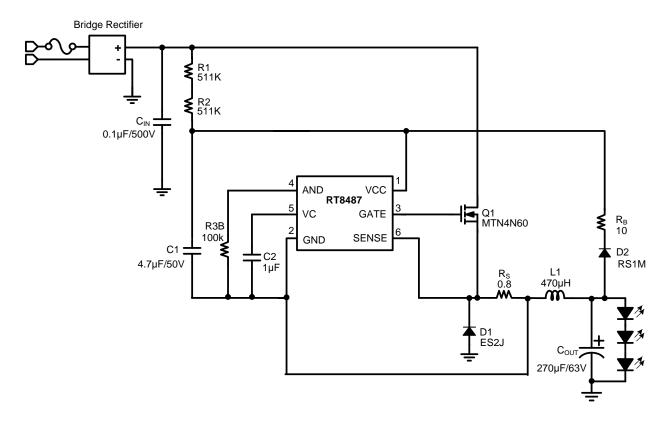
Parai	meter	Symbol	Test Conditions	Min	Тур	Max	Unit	
VCC UVLO ON	١	V <sub>UVLO_ON</sub>		17 18		19	V	
VCC UVLO OFF		V <sub>U</sub> VLO_OFF		6.4	7.2	8	V	
VCC Shutdown Current		I <sub>SD</sub>	VCC = VUVLO_ON - 3V			1	μΑ	
VCC Quiescent Current		IQC	Gate stands still		0.5	5	mΑ	
VCC Operating Current		Icc	By CGATE = 1nF, Freq.= 20kHz		1	5	mA	
VCC OVP Level		Vovp		32	34	39.5	V	
Sense Pin Lea	kage Current	I <sub>SENSE</sub>	V <sub>SENSE</sub> = 3V		1	5	μΑ	
Current Sense Threshold		V <sub>SENSE</sub>		242.5	250	257.5	mV	
AND Pin Leakage Current		I <sub>AND</sub>	V <sub>AND</sub> = 5V		1	2	μΑ	
GATE Voltage High		VGATE_H	I <sub>GATE</sub> = 0mA	10.5	12		V	
			IGATE = 10mA	9	10			
GATE Driver	Rising Time	tr			50		20	
	Falling Time	t <sub>f</sub>			25		ns	

- **Note 1.** Stresses beyond those listed "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability
- **Note 2.**  $\theta_{JA}$  is measured under natural convection (still air) at  $T_A = 25^{\circ}\text{C}$  with the component mounted on a high effective-thermal-conductivity four-layer test board on a JEDEC 51-7 thermal measurement standard.
- Note 3. Devices are ESD sensitive. Handling precaution recommended.
- $\textbf{Note 4.} \ \ \textbf{The device is not guaranteed to function outside its operating conditions.}$



## **Typical Application Circuit**

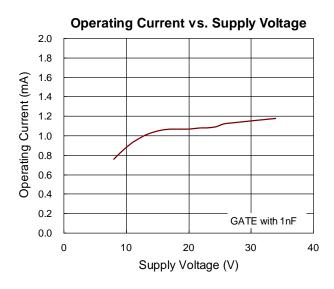
Buck:

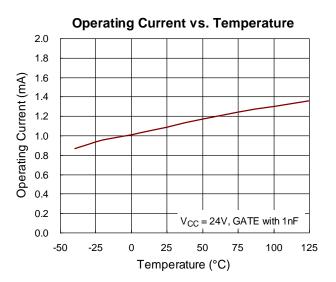


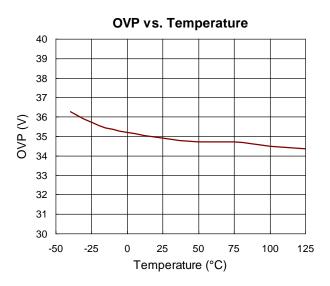
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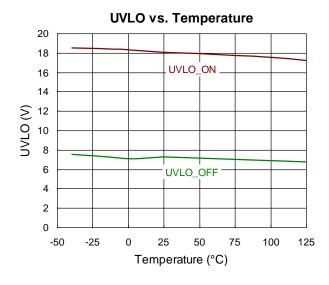


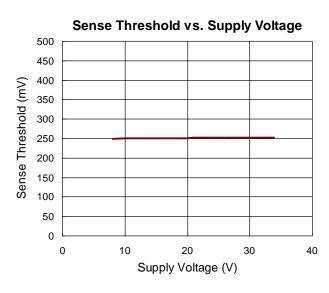
## **Typical Operating Characteristics**

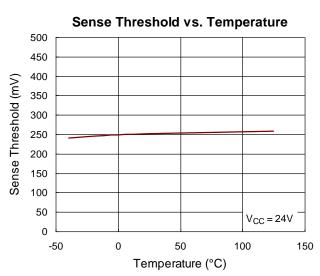




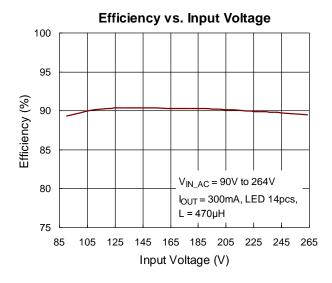


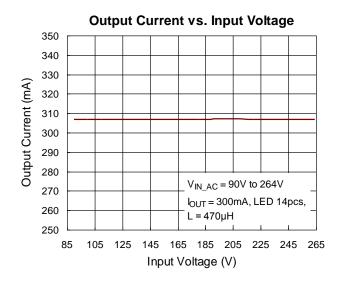


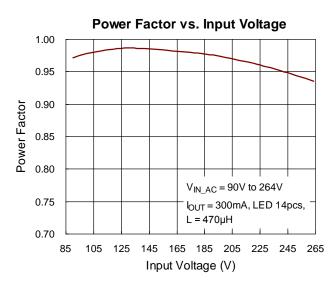


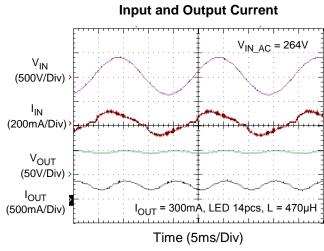


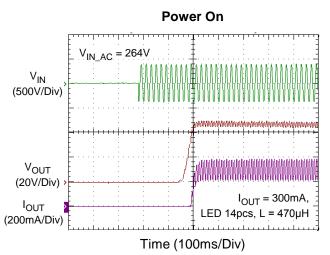


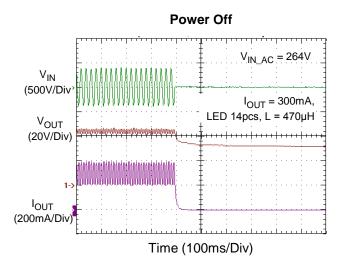






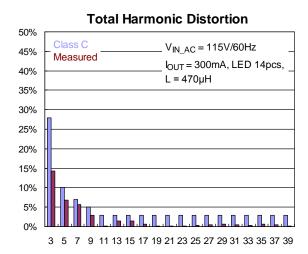


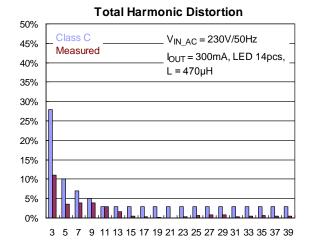




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## **Application Information**

The RT8487 is a boundary mode, high efficiency constant current controller with internal high side driver, which can be used in buck and buck-boost configuration, to provide a constant output current to the (LED) load. It contains special circuitry for achieving high power factor and low input current THD, while minimizing external component count. The small SOT23-6 package keeps application footprint small, and makes the RT8487 a cost effective solution for off-line LED drivers.

The RT8487 can achieve high accuracy LED output current via the average current feedback loop control. The internal sense voltage (250mV typ.) is used to set the average output current. The average current is set by the external resistor, RS. The sense voltage is also used for over current protection(OCP) function. The typical OCP threshold is about seven times of the sense voltage threshold.

#### **Under Voltage Lockout (UVLO)**

The RT8487 includes a UVLO function with 10.8V hysteresis.

For system start up, the VIN must rise over 18V (typ.) to turn on the GATE terminal.

The GATE terminal will turn off if VIN falls below 7.2V (typ.)

#### **Setting Average Output Current**

The output current that flows through the LED string is set by an external resistor, RS, which is connected between

the GND and SENSE pins. The relationship between output current, IOUT, and Rs is shown below :

$$I_{OUT} = \frac{250}{R_e} (mA)$$

#### **Start-Up Resistor**

The start-up resistor should be chosen to set the start

up current exceeds certain minimum value. Otherwise, the RT8487 may latch off and the system will never start. The start-up current equals  $(\sqrt{2} \times 90 \text{V}) / (\text{R1 +R2})$ 

(for 110VAC regions), and equals 
$$(\sqrt{2} \times 180 \text{V}) / (\text{R1 +R2})$$

(for 220VAC regions). The typical required minimum start-up current is  $100\mu A$ . The typical total start up resistance (R1 + R2) is around 1M Ohm for universal inputs.

#### Input Diode Bridge Rectifier Selection

The current rating of the input bridge rectifier is dependent on the  $V_{OUT}$  / $V_{IN}$  conversion ratio and out LED current. The voltage rating of the input bridge rectifier,  $V_{BR}$ , on the other hand, is only dependent on the input voltage. Thus, the  $V_{BR}$  rating is

$$V_{BR} = 1.2 \times (\sqrt{2} \times V_{AC(MAX)})$$

calculated as below:

where  $V_{AC(MAX)}$  is the maximum input voltage (RMS) and the parameter 1.2 is used for safety margin.

For this example:

$$V_{BR} = 1.2 \times \left(\sqrt{2} \times V_{AC(MAX)}\right) = \left(1.2 \times \sqrt{2} \times 264\right) = 448V$$

If the input source is universal, VBR will reach 448V. In this case, a 600V, 0.5A bridge rectifier can be chosen.

#### Input Capacitor Selection

For High Power Factor application, the input Capacitor C<sub>IN</sub> should use a small value capacitance to achieve line voltage sine-wave.

The voltage rating of the input filter capacitor, V<sub>CIN</sub>, should be large enough to handle the input voltage.

$$V_{IN} \ge 1.2 \times (\sqrt{2} \times V_{AC(MAX)}) = (1.2 \times \sqrt{2} \times 264) = 448V$$

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Thus, a  $0.1 \mu F$  / 500V film capacitor can be chosen in this case.

#### **Inductor Selection**

For high power factor application, the RT8487 operates the converter in BCM (Boundary-Condition Mode). The inductance range is defined by peak current of inductor maximum and minimum value of switching on time and off time, for ensuring the inductor operates in BCM. The peak current of inductor is showed as below:

$$I_{PEAK} = \frac{2Pin}{V_{PEAK}F(a)}$$

where 
$$a = \frac{V_{OUT}}{V_{PEAK}}$$

and

$$F(a) \approx -0.411a^4 + 0.296a^3 - 0.312a^2 + 0.638a - 0.0000846,$$
  
 $\{a|0 \sim 0.7\}$ 

The inductance range is showed as below:

$$L = \frac{V_{OUT}T_{OFF}}{I_{PEAK}} = \frac{\left(V_{PEAK} - V_{OUT}\right)T_{ON}}{I_{PEAK}}$$

Where  $0.5\mu s \le T_{ON} \le 35\mu s$  and  $2\mu s \le T_{OFF} \le 30\mu s$  The frequency at the top of the sine wave can be calculated :

$$f_{SW} = \frac{1}{T_{ON} + T_{OFF} + T_{DELAY}}$$

 $(T_{DELAY})$  is determined by the resistor connected to AND pin , see Turn on delay time)

### **Turn On Delay Time**

After the inductor current has reached zero, a resonance will occur between the inductor and the MOSFET drain-source capacitance.

In order to minimize the MOSFET switching losses, the RT8487 provides the flexibility to adjust the delay time of next switch-on cycle in order to switch-on at the maximum point of the resonance, which corresponds to the minimum drain-source voltage value.

The delay time from zero current point to the maximum of the switch resonance which can be calculated from :

$$T_{resonance} = \pi \sqrt{L1 \times C_{SW}}$$

where C<sub>SW</sub> is the capacitance at the switch node, mostly determined by the MOSFET drain-source capacitance.

The delay time T<sub>DELAY</sub> from zero current detection point to next MOSFET switch-on cycle can be adjusted by the resistor value R3B connected between AND pin and IC GND

 $T_{DELAY}$ (μs)=(-0.4 x R3B<sup>2</sup>+3500 x R3B+407500) x 10<sup>-6</sup> R3B resister value in kΩ.

#### **Forward Diode Selection**

When the power switch turns off, the path for the current is through the diode connected between the switch output and ground. This forward biased diode must have minimum voltage drop and recovery time. The reverse voltage rating of the diode should be greater than the maximum input voltage and the current rating should be greater than the maximum load current.

The peak voltage stress of diode is:

$$V_D \; \geq \; 1.2 \times \left(\sqrt{2} \times \; V_{AC(MAX)}\right) = 1.2 \times \left(\sqrt{2} \times \; 264\right) = 448 V$$

The input source is universal ( $V_{IN} = 85V$  to 264V),  $V_D$  will reach 448V.

## **MOSFET Selection**

The peak current through this MOSFET will be over the maximum output current. This component current rating

should be greater than 1.2 times the maximum load current and the reverse voltage rating of the MOSFET should be greater than 1.2 times the maximum input voltage, assuming a ±20% output current ripple.

The peak voltage rating of the MOSFET is:

$$V_{Q1} = 1.2 \times (\sqrt{2} \times V_{AC(MAX)}) = 1.2 \times (\sqrt{2} \times 264) = 448V$$

The largest peak current will occur at the highest V<sub>IN</sub>. The current rating of MOSFET is determined by the



OCP threshold which is about seven times of the sense voltage threshold.

### **Thermal Protection (OTP)**

A thermal protection feature is included to protect the RT8487 from excessive heat damage. When the junction temperature exceeds a threshold of 150°C, the thermal protection OTP will be triggered and the GATE will be turned off.

#### **Thermal Considerations**

The junction temperature should never exceed the absolute maximum junction temperature T<sub>J(MAX)</sub>, listed under Absolute Maximum Ratings, to avoid permanent damage to the device. The maximum allowable power dissipation depends on the thermal resistance of the IC package, the PCB layout, the rate of surrounding airflow, and the difference between the junction and ambient temperatures. The maximum power dissipation can be calculated using the following formula:

 $P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$ 

where  $T_{J(MAX)}$  is the maximum junction temperature,  $T_A$  is the ambient temperature, and  $\theta_{JA}$  is the junction-to-ambient thermal resistance.

For continuous operation, the maximum operating junction temperature indicated under Recommended Operating Conditions is 125°C. The junction-to-

ambient thermal resistance,  $\theta_{JA}$ , is highly package dependent. For a TSOT-23-6 package, the thermal resistance,  $\theta_{JA}$ , is 197.4°C/W on a standard JEDEC 51-7 high effective-thermal-conductivity four-layer test board. The maximum power dissipation at  $T_A = 25$ °C can be calculated as below:

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (197.4^{\circ}C/W) = 0.5W$  for a TSOT-23-6 package.

The maximum power dissipation depends on the

operating ambient temperature for the fixed  $T_{J(MAX)}$  and the thermal resistance,  $\theta_{JA}$ . The derating curves in Figure 1 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

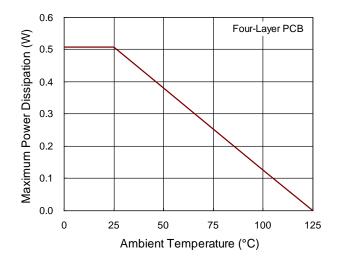


Figure 1. Derating Curve of Maximum Power
Dissipation

#### **Layout Considerations**

For best performance of the RT8487, the following layout guidelines should be strictly followed.

- ► The hold up capacitor, C1, must be placed as close as possible to the VCC pin.
- ► The compensation capacitor, C2, and delay resistor, R3B, must be placed as close as possible to the VC and the AND pin.
- ► The IC GATE and GND pin are high frequency switching nodes. Both traces must be as wide and short as possible.
- ► Keep the main traces with switching current as short and wide as possible.
- ▶ Place C<sub>IN</sub>, L1, Q1, Rs, C<sub>OUT</sub>, and D1 as close to each other as possible.

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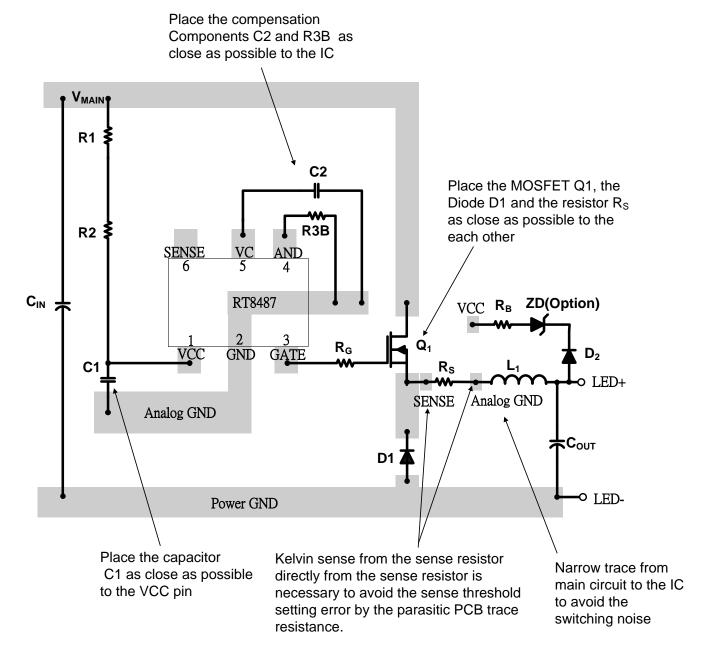
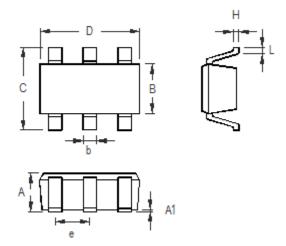


Figure 2. PCB Layout Guide



## **Outline Dimension**



Symbol	Dimensions I	In Millimeters	Dimensions In Inches		
	Min	Max	Min	Max	
А	0.700	1.000	0.028	0.039	
A1	0.000	0.100	0.000	0.004	
В	1.397	1.803	0.055	0.071	
b	0.300	0.559	0.012	0.022	
С	2.591	3.000	0.102	0.118	
D	2.692	3.099	0.106	0.122	
е	0.838	1.041	0.033	0.041	
Н	0.080	0.254	0.003	0.010	
L	0.300	0.610	0.012	0.024	

**TSOT-23-6 Surface Mount Package** 

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